

SANGAM RISE FOUNDATION

Sangam University, Panchayat Atun, Pur Road, Bhilwara- 311001, Rajasthan

E-mail: sangamrise@sangamuniversity.ac.in

(Section 8 Company registered under the Companies Act, 2013 (18 of 2013))

NOTICE INVITING OPEN TENDER

Bidding Document

(For Procurement of Computer Systems & ICT items)

Open Tender under Two Cover System

Last Date for Bid Submission is 13-11-2024

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NOTICE INVITING TENDER

Tender No.: Sangam/SRF/ICT ITEMS/2024/01 Date: 26-10-2024

“Tender for Procurement of Computer Systems & ICT items”

Sangam University Bhilwara, Rajasthan is one of the reputed Private Universities in the Rajasthan. **Sangam i-TBI (NIDHI Inclusive Technology Business Incubator)** is a Project under the Department to promote Technology based Entrepreneurship and Innovation. Sealed quotations are invited under two bids, Technical & financial bids in two separate sealed envelopes and EMD & Tender fess in another envelope contained in one bigger envelope) for the Supply of Computer Systems ICT items. Detailed Specifications are in Technical Bid of this tender.

CONTENTS OF TENDER DOCUMENT

S.No.	Requirement	Procurement of Computer Systems & ICT items.
1	Tender issue no. and Date	Sangam/SRF/ICT ITEMS/2024/01 Date: 26-10-2024
2	Technical Bid	The details of requirement along with Technical parameter to be submitted with Technical Bid (Technical Bid of this tender)
3	Financial Bid	The details available in financial Bid this tender
4	Tender Fees	Rs.1000/- (Rupees One hundred only)
5	Earnest Money Deposit along with Tender	Rs. 2% of the Tender Cost.
6	Tender Publish Date	29-10-2024
7	Last date of Submission of tender	13-11-2024 on 05:00 P.M.
8	Date of Opening of Technical Bid	14-11-2024 on 01:00 P.M
9	Tender Publish Date	29-10-2024
10	Bid Validity days	90 Days
11	Performance Security	5%
12	Warranty	3 Years
13	Address for Communication	Chairman Finance and Purchase Committee, Sangam Rise Foundation, Sangam University, Panchayat Atun, Pur Road, Bhilwara- 311001, Rajasthan E-mail: sangamrise@sangamuniversity.ac.in

**Chairman Finance and Purchase Committee
Sangam Rise Foundation
Sangam University, Bhilwara, Rajasthan**

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Sangam i-TBI (NIDHI Inclusive Technology Business Incubator) Project Funded under Government of India Ministry of Science & Technology Department of Science & Technology-Technology Translation and Innovation {Procurement of Computer Systems & ICT items}			
Sr. No	ITEMS	QUANTITY	Estimated Cost in Rs.
1	Desktop	2 Nos	Rs 21,43,000/-
2	UPS Support – 1 nos for 20 Systems	1 Nos	(Rs Twenty One lakh Forty
3	Multicolor Printer with Photocopying Facility	2 Nos	Three Thousand only)
4	Laptop	5 Nos	Tender Fees Rs. 1000/-
5	Digital Podium-Metallic Integrated Podium	1 Nos	EMD 2% tender cost/-
6	Multi Touch Monitor	1 Nos	By DD In favor “Sangam Rise
7	Computer System-i7/13 th Gen/8 GB RAM/512 GB SSD Window 11 Audio System	1 Nos	Foundation payable at Bhilwara
8	3 D Printer (RESIN) Printing Material: Resin Build Volume:5’’x5’’x5’’ Supported file type: STL,OBJ Software: From Labs Perform	1 Nos	<u>For NEFT/RTGS</u> Sangam Rise Foundation AU Small Finance Bank
9	Video Recording (DSLR+V.C Room)	1 Nos	Account No: 2402223155987891
10	Projector	1 Nos	IFSC CODE:AUBL0002231

*****News Paper Advertisement:-**

<p style="text-align: center;">SANGAM RISE FOUNDATION Sangam University, Panchayat Atun, Pur Road, Bhilwara- 311001, Rajasthan E-mail: sangamrise@sangamuniversity.ac.in (Section 8 Company registered under the Companies Act, 2013 (18 of 2013))</p> <hr/> <p style="text-align: center;"><u>OPEN-TENDER NOTICE</u></p> <p style="text-align: center;">TenderNo.: Sangam/SRF/ICT ITEMS/2024/01 Date: 29-10-2024</p> <p>Open Tenders are invited on or before 13-11-2024 till 05:00 PM from reputed firms for Procurement of Computer Systems & ICT items(Estimated cost Rs Twenty One lakh Forty Three Thousand only). Other details can be downloading from University website www.sangamuniversity.ac.in.</p>
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**Chairman Finance and Purchase Committee
Sangam Rise Foundation
Sangam University, Bhilwara, Rajasthan**

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INSTRUCTIONSTOTENDERER

Tender documents can be downloaded website from Sangam University Bhilwara, Rajasthan sangamuniversity.ac.in 29-10-2024 to 13-11-2024. A Demand Draft in favor of “Sangam Rise Foundation” payable at Bhilwara Tender Fees may be enclosed in a separate Envelope-1.

1. The Earnest Money Deposit of Rs. 42,860/- (Rs. Forty Two Thousand Eight Hundred Sixty only) by way of Demand Draft only drawn in favor of “Sangam Rise Foundation” payable at Bhilwara shall be submitted along with Tender in Envelope-1 as explained bid Documents. The offers without EMD will be rejected. (NEFT/RTGS facility acceptable bank account no. maintain on page no.03)
2. The Quantity of Computer Systems & ICT items required maintain in bid. The said quantity is a tentative number and may vary as per requirement.
3. Tender shall be duly, properly and exhaustively filled in places wherever required in Bid Documents. All Pages of the tender should be signed with company stamp by the Authorized Signatory of Tenderer.
4. Tenderer shall submit a list of major clients with complete contact details whom similar services have been provided during last 3year.
5. Any cutting/over writing etc. in the tender must be signed by the person who is signing the tender. The rates and units shall not be overwritten. The financial figures in financial bid shall always be both in figures and words. Incase of any discrepancy in figures and words, the amount written in words shall be considered.
6. The tenderer shall submit duly filled tender in the prescribed format in a sealedenvelopeby13-11-2024upto05:00PMattheofficeof **Chairman Finance and Purchase Committee, Sangam Rise Foundation, Sangam University, Panchayat Atun, Pur Road, Bhilwara- 311001, Rajasthan.** The sealed envelope should be super-scribed as “Tender for Computer Systems & ICT’ items” and its due date. The sealed envelope should contain three sealed envelopes inside it as described below-
Envelope-1 shall contain EMD &tender fees both in the form of Demand Draft in favor of “Sangam Rise Foundation” payable at Bhilwara”. In case the tender documents collected by hand, a cash receipt towards cost of tender shall be enclosed. The units Exempted from EMD shall enclose a valid certificate in this envelope.Thesaidenvelopeshallbesealedandbesuperscriptedas‘EMD&CostofTenderfor Procurement of Computer Systems & ICT items.

Envelope-2shallcontainTechnicalBidcompletedinallrespectsincluding

- Annexure–I duly filled up
- Copies of PAN, TIN/Service Tax/VAT/GST registration etc.
- Client list in prescribed format as given in Annex.
- Duly signed & stamped all pages of this tender, The Envelope shall be sealed and super scripted as ‘Technical Bid Procurement of Computer Systems & ICT items’.

Envelope-3 shall contain Financial Bid with Price Offer filled in prescribed format in Annex. II. The sealed envelope shall be superscripted as 'Financial Bid for Computer Systems & ICT items'.

The tender received within the stipulated date and time will be opened at the office of Chairman Finance and Purchase Committee, Sangam Rise Foundation, Sangam University, Panchayat Atun, Pur Road, Bhilwara-311001, Rajasthan, in the presence of available tenders, on 14.11.2024 at 01:00 P.M. The Tenderer or their authorized representative (One person only) may be present at the time of opening of the tender. The date for opening second envelope containing financial bid will be intimated to the qualified bidders separately.

7. The Tenderers shall seek clarifications if any before submitting the tender.

8. Tenderer shall take into account all costs including installation, cartage etc. for Procurement of Computer Systems & ICT items at site i.e. Sangam University Bhilwara, Rajasthan before quoting the rates. In this regard no claim for any extra payment for any reason shall be entertained.

9. All the communication with respect to the tender shall be addressed to:

To,

**Chairman Finance and Purchase Committee, Sangam Rise
Foundation, Sangam University, Panchayat Atun, Pur
Road, Bhilwara- 311001, Rajasthan**

E-mail: sangamrise@sangamuniversity.ac.in

**Chairman Finance and Purchase Committee
Sangam Rise Foundation
Sangam University, Bhilwara, Rajasthan**

SANGAM RISE FOUNDATION

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TERMS AND CONDITIONS

Submission of the duly signed tender implies that these conditions of tender have been read by the Tenderer and is aware of the scope of the supply i.e. supply of "Computer Systems & ICT items". The final acceptance of the tender rests with the Chairman Finance and Purchase Committee, Sangam Rise Foundation, Sangam University, Panchayat Atun, Pur Road, Bhilwara- 311001, Rajasthan, who reserves the right to accept or reject any or all tenders at any stage of this tender process without assigning any reason therefore.

1. The Procurement of Computer Systems & ICT items shall be in compliance to the specifications mentioned in Technical Bid.
2. The Windows Operating System software and other software preloaded in all the systems shall be licensed and a document supporting the license & validity shall be submitted with delivery of computers.
3. The delivery period of the first supplies should be within 30 days from the date of confirmed order from Chairman Finance and Purchase Committee, Sangam Rise Foundation, Sangam University, Panchayat Atun, Pur Road, Bhilwara- 311001, Rajasthan. In Case tenderer fails to supply within the accepted period, EMD shall be forfeited.
4. The successful bidder shall be responsible for smooth functioning of each system supplied. Any complaint shall be addressed within three working days of reporting. In case, resolving the complaint takes longer than three days, supplier shall replace with another computer system/ICT system on third working day.
5. **Validity period** of the quotation shall be minimum 03 Months from the date of opening of this tender.
6. All the pages of this tender shall be signed with date by the Authorized Signatory of tenderer with their company stamp & submitted along with Technical Bid.
7. Tender is liable to be rejected in case EMD at prescribed rate is not furnished along with the tender.
8. The EMD will be returned to the unsuccessful bidders soon after the orders are placed on the successful bidder. In case of successful bidder, the EMD amount shall be retained and shall be released at the end of contract. Chairman Finance and Purchase Committee, Sangam Rise Foundation, Sangam University, Panchayat Atun, Pur Road, Bhilwara- 311001, Rajasthan shall not be liable for payment of any interest on EMD.

9. The EMD will be forfeited in following cases:
 - i. If the bidder fails to accept the order based on his offer (bid) and within the prescribed time.
 - ii. If the bidder delays supplies beyond a reasonable time resulting in disruption of Chairman Finance and Purchase Committee, Sangam Rise Foundation, Sangam University, Panchayat Atun, Pur Road, Bhilwara- 311001, Rajasthan works.
- 10.**The price quoted shall be final & firm, however any variation in the taxes, duties, levies etc. during the period of supplies shall be paid as applicable at that time. No representation for the enhancement of the accepted tender or alteration of the terms and conditions will be entertained during the period of contract.
- 11.Payment on yearly basis will be released at the end of proper installation subject to satisfactory performance. The supplier shall submit a tax invoice on yearly for the release of payment.
- 12.The tenders received after the stipulated date and time or tender received with conditions will not be accepted. Tenders not submitted in the prescribed form or incomplete in any form are liable to be rejected. Tenders which propose any alterations in the conditions specified will be rejected.
- 13.Chairman Finance and Purchase Committee, Sangam Rise Foundation, Sangam University, Panchayat Atun, Pur Road, Bhilwara- 311001, Rajasthan reserves the right to reject any bid/tender wholly or partly at any stage of tendering without assigning any reason.
- 14.In case the services are not found satisfactory or any complaint is not attended within 7working days, Chairman Finance and Purchase Committee, Sangam Rise Foundation, Sangam University, Panchayat Atun, Pur Road, Bhilwara- 311001, Rajasthan reserves the right to terminate the services with immediate effect.
- 15.In case the Supplier wishes to withdraw its services, it shall give a notice period of minimum one Months before taking its Computer Systems/ICT items.
- 16.In the event of any dispute the legal matter shall be subjected to the jurisdiction of Bhilwara Court only.
- 17.This tender does not have any binding on Chairman Finance and Purchase Committee, Sangam Rise Foundation, Sangam University, Panchayat Atun, Pur Road, Bhilwara- 311001, Rajasthan for acceptance of the Tender.
- 18.The Bidder shall, on intimation of acceptance of the bid from the Chairman Finance and Purchase Committee, Sangam Rise Foundation, Sangam University, Panchayat Atun, Pur Road, Bhilwara- 311001, Rajasthan submit an agreement bond on non-judicial stamp of Rs 1000/- for prompt supplies, within period specified in the letter and also deposit the amount of security money if required under above terms and condition along with the agreement bond failing which the earnest money deposited with the bid will be forfeited.
- 19.Liquidated Damages (L.D.):**
If a supplier fails to execute the order in time as per the terms and conditions stipulated therein, it

will be opened to the purchaser to recover liquidated damages for delay in delivery and installation from the supplier as per the provisions of Rajasthan Transparency in Public Procurement Act 2012 (Act No.21 of 2012) Rules 2013 Govt. of Rajasthan / GF& AR and amended from time to time. The L.D. charges can be increased in case of gross violation of the purchase order terms as decided by the Chairman Finance and Purchase Committee, Sangam Rise Foundation, Sangam University, Panchayat Atun, Pur Road, Bhilwara 311001, Rajasthan of the University.

- (a) Delay upto 1/4th of the time period of supply:2.5%
- (b) Delay 1/4th and above but less than ½ of supply period:5%
- (c) Delay ½ and above but less than 3/4th of the supply period:7.5%
- (d) Delay more than 3/4th of the time period of supply:10%

If the delay is more than 30 days from the period of supply mentioned in the order, department/purchasing officer may deduct amount after evaluating loss due to the delay.

20. Whether the firm is black listed from any Govt. Institution/University, please provide a certificate on 50/- Rs. Non- Judicial Stamp paper.

21. The provisions of **RTPP Act, 2013** and amendments thereto shall be applicable for this procurement. Furthermore, in case of any inconsistency in any of the bidding document with the RTPP Act, 2018 (second amendment) and Rules thereto (amended upto 25-07-2019), the later shall prevail.

22. **Transfer and Subletting:** The supplier shall not sublet, transfer, assign or otherwise part with the acceptance to the tender or any part thereof, either directly or indirectly, without the prior written permission of the Purchaser.

23. **Payment:** The payment to the supplier will be made after successful installation of the equipment.

- **Additional Points:** If the ITEM supplied by the Bidder fails during the warranty period, the supplier is required to repair/replace faulty devices/components/parts. If the ITEM shows frequent failure and requires frequent repair during warranty period, the supplier is required to replace the system free of cost.
- If there is any updation/ additional information in the submitted tender. A corrigendum will be published on the university website as per prevalent rules. Bidder needs to take into account the corrigendum published on university website before submitting the bids online.

24. **Defective Equipment:** If any of the equipment supplied by the Supplier is found to be substandard, refurbished, un-merchantable or not in accordance with the description/specification or otherwise faulty, the committee will have the right to reject the equipment or its part. The prices of such equipment shall be refunded by the Supplier with 18% interest if such payments for such equipment have already been made. All damaged or unapproved goods shall be returned at suppliers cost and risk and the incidental expenses incurred thereon shall be recovered from the supplier. Defective part (s) in equipment, if found before installation and/or during warranty period, shall be replaced within 30 days on receipt of the intimation from this office at the cost and risk of supplier including all other charges. In case supplier fails to replace above item as per above terms & conditions, Sangam University may consider "Banning" the supplier.

**Sign of Authorized Signatory
With Seal**

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Annexure -I

TECHNICAL BID

FORMAT & REQUIREMENTS

1. Tender Ref. No:.....
2. Name of Tenderer:.....
3. Complete office address of Tenderer.....
.....
.....
4. PAN Number of Tenderer (copy to be closed).....
5. GST number of Tenderer (copy to be enclosed).....
6. Contact details of authorized person of tenderer who have signed the tender
 - a. Name.....
 - b. Designation.....
 - c. Phone(Office).....
 - d. Phone(Mobile).....
 - e. Email.....
7. **Delivery period** after receipt of order 30 days. There after delivery period against each subsequent supply order 7 days, **Validity of quotation** from the date of opening of Bid 90 days.
8. EMD Details –Demand Draft No. & Date.....
9. Cost of Tender–Demand Draft No./Receipt No. & Date.....

10. Technical Details of “Computer Systems & ICT items”

S.No.	Specification: Procurement of Computer Systems & ICT items.	Quantity	Acceptance for Supplies By Bidder Specify Yes/No
1	<p>Desktop</p> <ul style="list-style-type: none"> • Operating system Windows 11 Home Single Language in S mode • Processor Name Intel® Core™ i7-13700 (up to 5.2 GHz with Intel® Turbo Boost Technology, 30 MB L3 cache, 16 cores, 24 threads <p>13th Generation Intel® Core™ i7 processor</p> <ul style="list-style-type: none"> • Chipset Intel® ADL H670 • Memory 16 GB DDR4-3200 RAM (2 x 8 GB) • Memory slots 2 DIMM • Memory Note Transfer rates up to 3200 MT/s. • STORAGE Hard drive description <ul style="list-style-type: none"> 256 PCIe® NVMe™ M.2 SSD Hard drive description (2nd 1 TB 7200 rpm SATA HDD Storage type SSD, HDD • Optical drive <p>Optical drive not included</p> <ul style="list-style-type: none"> • Cloud service <p>Intel® UHD Graphics 770</p> <ul style="list-style-type: none"> • EXPANSION FEATURES • I/O Port location <p>Front</p> <ul style="list-style-type: none"> • Ports <p>4 SuperSpeed USB Type-A 5Gbps signaling rate; 1 headphone/microphone combo</p> <ul style="list-style-type: none"> • I/O Port location <p>Rear</p> <ul style="list-style-type: none"> • Ports <p>4 USB 2.0 Type-A; 1 audio-in; 1 audio-out; 1 RJ-45</p> <ul style="list-style-type: none"> • Expansion slots <p>2 M.2; 1 PCIe x16; 1 PCIe x1</p> <ul style="list-style-type: none"> • Video connectors 	2 Nos	

	<p>1 VGA; 1 HDMI-out 1.4b</p> <ul style="list-style-type: none"> • INPUT DEVICES • Pointing device <p>USB Black Wired Mouse</p> <ul style="list-style-type: none"> • Keyboard <p>USB Black Wired Keyboard</p> <ul style="list-style-type: none"> • COMMUNICATIONS • Network interface <p>Integrated 10/100/1000 GbE LAN</p> <ul style="list-style-type: none"> • Wireless <p>Realtek RTL8822CE 802.11 a/b/g/n/ac (2x2) Wi-Fi® and Bluetooth® 5 wireless card</p> <ul style="list-style-type: none"> • 46.9 cm (18.5) HD (1366 x 768 @ 60 Hz) • Flat TN with Edge-lit • 1 VGA, 1 HDMI 1.4 (with HDCP support) • Tilt Stand • Anti-glare, Low blue light mode 																														
2	<p>UPS Support –For 20 Systems</p> <table border="1" data-bbox="321 1100 1289 1969"> <tr> <td>Capacity / Rating</td> <td>3.7KVA / 2960W</td> </tr> <tr> <td>Standard Input Voltage</td> <td>100V~280V</td> </tr> <tr> <td>Narrow Input Voltage</td> <td>180V~260V</td> </tr> <tr> <td>Output Voltage on Main Mode</td> <td>Same as Input</td> </tr> <tr> <td>Output Voltage on UPS mode</td> <td>220V±10%</td> </tr> <tr> <td>Output Frequency on UPS Mode</td> <td>50Hz±0.5Hz</td> </tr> <tr> <td>Switching form mains to UPS and UPS to mains</td> <td>Automatic</td> </tr> <tr> <td>Output wave from on mains mode</td> <td>Same as input</td> </tr> <tr> <td>Output wave from on backup mode</td> <td>Pure Sinewave</td> </tr> <tr> <td>Battery charging current</td> <td>Max Charge Current 20A±3A</td> </tr> <tr> <td>Battery Charger</td> <td>Boost Based PWM Control Multi-Stage IBM technology</td> </tr> <tr> <td>Efficiency</td> <td>>80%</td> </tr> <tr> <td>Input Brown Out Voltage</td> <td>100V±10V</td> </tr> <tr> <td>UPS Overload</td> <td>108% of the Rated Capacity</td> </tr> </table>	Capacity / Rating	3.7KVA / 2960W	Standard Input Voltage	100V~280V	Narrow Input Voltage	180V~260V	Output Voltage on Main Mode	Same as Input	Output Voltage on UPS mode	220V±10%	Output Frequency on UPS Mode	50Hz±0.5Hz	Switching form mains to UPS and UPS to mains	Automatic	Output wave from on mains mode	Same as input	Output wave from on backup mode	Pure Sinewave	Battery charging current	Max Charge Current 20A±3A	Battery Charger	Boost Based PWM Control Multi-Stage IBM technology	Efficiency	>80%	Input Brown Out Voltage	100V±10V	UPS Overload	108% of the Rated Capacity	1 Nos	
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	Technology	DSP Based Smart Control Design		
	Auto Reset Feature	Yes		
	Environmental Parameters	Operating Temperature: 0~45°C / Acoustic Noise at 1 Mtr: <60dB Relative Humidity: MAX 95% Non- Condensing / Thermal Management: Integrated cooling (Fan & Heat sink)		
	Mains to Bypass	Rotary/Rocker Bypass Switch		
	Display	LCD/LED Display Indicator		
	Capacity (Ah)	135		
	Maximum Overall Dimensions (CM) W*L*H	52 x 27.9 x 28.3 (±2 mm)		
	Battery Type	Jumbo Tubular		
	Battery Warranty	42 Months (21 Months free of cost + 21 Months Pro Rata)		
3	<p>Multicolor Printer with Photocopying FacilityPrint</p> <ul style="list-style-type: none"> • Printing Speed ISO/IEC 24734 • 25 pages/min Monochrome, 12 pages/min Colour • Printing Speed • 32 pages/min Monochrome (plain paper 75 g/m²), 22 pages/min Colour (plain paper 75 g/m²) • Duplex Printing Speed ISO/IEC 24734 • 16 A4 Pages/min Monochrome, 9 A4 Pages/min Colour • Monochrome 5,5 Seconds, Colour 8,5 Seconds • Black [Pigment], Cyan [Pigment], Yellow [Pigment], Magenta [Pigment] <p>Scan</p> <ul style="list-style-type: none"> • Double-sided scanning • Single-sided scan speed (A4 black) • 26 ipm with ADF scan 5 sec. with flatbed scan • Doubled-sided scan speed (A4 black) • 11,5 ipm with ADF scan • Single-sided scan speed (A4 colour) 		2 Nos	

	<ul style="list-style-type: none"> • 9 ipm with ADF scan 10 sec. with flatbed scan • Doubled-sided scan speed (A4 colour) • 6 ipm with ADF scan • Optical Resolution • 2.400 DPI x 1.200 DPI (Horizontal x Vertical) • Output formats • BMP, JPEG, TIFF, multi-TIFF, PDF, PNG • Scanner type • Contact image sensor (CIS) 																																																												
4	<p>Laptop</p> <p>Processor: Intel i5-1235U (3.30 GHz up to 4.40 GHz), 10 Cores & 12MB Cache</p> <p>RAM & Storage: 8GB, 8Gx1, DDR4, 2666MHz Ach & 512GB SSD</p> <p>Display & Graphics: 15.6" FHD WVA AG 120Hz 250 nits Narrow Border & Integrated</p> <p>Keyboard & Warranty: Standard Keyboard & 1 Year Onsite Hardware Service</p> <p>Ports: 2 USB 3.2 Gen 1 ports, 1 USB 2.0 port, 1 Headset jack, 1 HDMI 1.4 port*, 1 M.2 for solid-state drive, 1 SD 3.0 card slot</p> <p>Processor: Intel i5-1235U (3.30 GHz up to 4.40 GHz), 10 Cores & 12MB Cache</p> <table border="1"> <tr> <td>Form Factor</td> <td>Laptop</td> </tr> <tr> <td>Item Height</td> <td>21 Millimeters</td> </tr> <tr> <td>Item Width</td> <td>35.8 Centimeters</td> </tr> <tr> <td>Standing screen display size</td> <td>15.6 Inches</td> </tr> <tr> <td>Screen Resolution</td> <td>1920 x 1080 pixels</td> </tr> <tr> <td>Resolution</td> <td>1920 x 1080 Pixels</td> </tr> <tr> <td>Product Dimensions</td> <td>23.5 x 35.8 x 2.1 cm; 1.65 kg</td> </tr> <tr> <td>Batteries</td> <td>1 Lithium Ion batteries required. (included)</td> </tr> <tr> <td>Processor Brand</td> <td>Intel</td> </tr> <tr> <td>Processor Type</td> <td>Core i5</td> </tr> <tr> <td>Processor Speed</td> <td>3.3 GHz</td> </tr> <tr> <td>Processor Count</td> <td>1</td> </tr> <tr> <td>RAM Size</td> <td>8 GB</td> </tr> <tr> <td>Memory Technology</td> <td>DDR4</td> </tr> <tr> <td>Computer Memory Type</td> <td>DDR4 SDRAM</td> </tr> <tr> <td>Maximum Memory Supported</td> <td>16 GB</td> </tr> <tr> <td>Memory Clock Speed</td> <td>2666 MHz</td> </tr> <tr> <td>Hard Drive Size</td> <td>512 GB</td> </tr> <tr> <td>Hard Disk Description</td> <td>SSD</td> </tr> <tr> <td>Hard Drive Interface</td> <td>Solid State</td> </tr> <tr> <td>Audio Details</td> <td>Speakers</td> </tr> <tr> <td>Graphics Coprocessor</td> <td>Intel UHD Graphics</td> </tr> <tr> <td>Graphics Chipset Brand</td> <td>Intel</td> </tr> <tr> <td>Graphics Card Description</td> <td>Integrated</td> </tr> <tr> <td>Graphics RAM Type</td> <td>Shared</td> </tr> <tr> <td>Graphics Card Interface</td> <td>Integrated</td> </tr> <tr> <td>Connectivity Type</td> <td>Wi-Fi</td> </tr> <tr> <td>Number of USB 2.0 Ports</td> <td>1</td> </tr> <tr> <td>Number of USB 3.0 Ports</td> <td>2</td> </tr> </table>	Form Factor	Laptop	Item Height	21 Millimeters	Item Width	35.8 Centimeters	Standing screen display size	15.6 Inches	Screen Resolution	1920 x 1080 pixels	Resolution	1920 x 1080 Pixels	Product Dimensions	23.5 x 35.8 x 2.1 cm; 1.65 kg	Batteries	1 Lithium Ion batteries required. (included)	Processor Brand	Intel	Processor Type	Core i5	Processor Speed	3.3 GHz	Processor Count	1	RAM Size	8 GB	Memory Technology	DDR4	Computer Memory Type	DDR4 SDRAM	Maximum Memory Supported	16 GB	Memory Clock Speed	2666 MHz	Hard Drive Size	512 GB	Hard Disk Description	SSD	Hard Drive Interface	Solid State	Audio Details	Speakers	Graphics Coprocessor	Intel UHD Graphics	Graphics Chipset Brand	Intel	Graphics Card Description	Integrated	Graphics RAM Type	Shared	Graphics Card Interface	Integrated	Connectivity Type	Wi-Fi	Number of USB 2.0 Ports	1	Number of USB 3.0 Ports	2	5 Nos	
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	Number of HDMI Ports	1		
	Voltage	240 Volts		
	Wattage	41 Watt Hours		
	Optical Drive Type	CD-R		
	Rear Webcam Resolution	0.92 MP		
	Power Source	Battery Powered		
	Operating System	Windows 10		
	Average Battery Life (in hours)	4 Hours		
	Are Batteries Included	Yes		
	Lithium Battery Energy Content	41 Watt Hours		
	Number of Lithium Ion Cells	3		
5	Digital Podium-Metallic Integrated Podium with Multi Touch Monitor PODIUM STRUCTURE <ul style="list-style-type: none"> •Min 1.6mmhighqualitymetallicpowdercoatedbodywithkey lockfacility •Motorizedscreenitlts upto 45° •Frontlogodisplayprovisionwithflexibilitytochange •Powerdistributionfacilitywith8 – 12port6Amp modular Powersocketswithprotectedby32AMCB •Inbuilt spaceforPC,Amplifier,speakers •19”rackfacility •Drawerfordocumentcamera •Slidingtoptrayforcoveringmonitor andplaceforlaptop •Movingfacilitywith 4casterwheelcomprisesbreakingsystem •2fansforcoolingsystem •Cablemanagerforalltypesofcables •Ports on top–2 USB, 1 XLRfor microphone at top •Ports on bottom - 1xVGA in & 1x Out, 3.5mm Audio in & Out socket, 1X LAN port 10/1000 gbps. •1xHDMI In& Out, 1X 6 A power socket for Laptop with On/Off switch WIRINGFACILITY <ul style="list-style-type: none"> •HDMI cable connectivity with 3 HDMI input switching & 2 HDMI splitting cabling •PC audio connectivity with 3.5mm audio jack & 2 RCA cable •One VGA connectivity cable for external display for VGA connectivity •At the Top One or Two USB connectivity for Pen drive & at the bottom two USB Cable connectivity for external device •key-padtocontrol with audio video, projector system control •Sourceselectionfrom PC, VisualizerandLaptop <ul style="list-style-type: none"> •Input/output: 3x HDMI input/ multi-HDMI output, 3xVGAinput 2xVGAoutput 	1 Nos		
6	Multi Touch Monitor Minimum 75 Inches 4K UHD Touch Screen, Ultra Touch Display Interactive Flat Panel Monitor(3840 x 2160 Pixels) Android 13 and above configuration		1 Nos	
7	Computer System-i7/13 th Gen/8 GB RAM/512 GB SSD Window 11		1 Nos	

	Audio System- Portable Speaker minimum 660 Watts, Supports Bluetooth, USB, mSD, AUX with Dual UHF Wireless MIC																																																																
8	<p>3 D Printer (RESIN) Printing Material: Resin Build Volume:5''x5''x5''</p> <table border="1"> <thead> <tr> <th colspan="2">Printer and Printing Properties</th> </tr> </thead> <tbody> <tr> <td>Technology</td> <td>Fused Filament Fabrication (FDM)</td> </tr> <tr> <td>Print Head</td> <td>Single Extrusion Print Head</td> </tr> <tr> <td>Extruder Mechanism</td> <td>Single Direct Drive</td> </tr> <tr> <td>Filament Diameter</td> <td>1.75 mm</td> </tr> <tr> <td>Nozzle Diameter</td> <td>0.4 mm by default, 0.6 mm, 0.8 mm and 1 mm optional</td> </tr> <tr> <td>Layer Thickness</td> <td>100-600 Micron</td> </tr> <tr> <td>Xyz Precision</td> <td>X -10, Y -10, Z -1.56 Micron</td> </tr> <tr> <td>Print Accuracy</td> <td>± 250 Microns</td> </tr> <tr> <td>Print Speed</td> <td>25–120 mm/s Depending Upon Printing Material and Part Geometry</td> </tr> <tr> <td>Print Head Travel Speed</td> <td>25-150 mm/s</td> </tr> <tr> <td>Build Plate</td> <td>Glass Build Plate</td> </tr> <tr> <td>Heating Bed</td> <td>Silicon Heat Bed</td> </tr> <tr> <td>Build Plate Temperature</td> <td>Up to 100 °C</td> </tr> <tr> <td>Build Plate Levelling</td> <td>Auto Bed Levelling</td> </tr> <tr> <td>Supported Materials</td> <td>PLA, ABS, ASA, TPU, PETG, PC, PLA CF, PETG CF, ABS CF and many more (CF = Carbon Fibre)</td> </tr> <tr> <td>Nozzle Temperature</td> <td>Upto 285°C</td> </tr> <tr> <td>Connectivity</td> <td>SD Card, USB Port, Wi Fi, Bluetooth, LAN</td> </tr> <tr> <td>Filament Sensor</td> <td>Filament Runout Detection Filament Clogging Detection</td> </tr> <tr> <td>Resume Print After Power Loss</td> <td>Yes</td> </tr> <tr> <td>Motion Mechanism</td> <td>X on Belt Drive with Rail Guide Y on Belt Drive with Rail Guide Z on Ball Screw and Chromium Coated Steel Rods</td> </tr> <tr> <td></td> <td></td> </tr> </tbody> </table> <table border="1"> <thead> <tr> <th colspan="2">Power Requirements</th> </tr> </thead> <tbody> <tr> <td>Input</td> <td>100 -240V AC, 50-60Hz</td> </tr> </tbody> </table> <table border="1"> <thead> <tr> <th colspan="2">Ambient conditions</th> </tr> </thead> <tbody> <tr> <td>Operating Ambient Temperature</td> <td>15 -40° C, 10 -90% RH Non Condensing</td> </tr> <tr> <td>Chamber</td> <td>Fully Enclosed Chamber</td> </tr> </tbody> </table> <table border="1"> <thead> <tr> <th colspan="2">Software</th> </tr> </thead> <tbody> <tr> <td>Supported OS</td> <td>Mac OS, Windows and Linux</td> </tr> <tr> <td>File types</td> <td>STL, OBJ and 3MF</td> </tr> <tr> <td>Machine Code</td> <td>GCODE</td> </tr> </tbody> </table>	Printer and Printing Properties		Technology	Fused Filament Fabrication (FDM)	Print Head	Single Extrusion Print Head	Extruder Mechanism	Single Direct Drive	Filament Diameter	1.75 mm	Nozzle Diameter	0.4 mm by default, 0.6 mm, 0.8 mm and 1 mm optional	Layer Thickness	100-600 Micron	Xyz Precision	X -10, Y -10, Z -1.56 Micron	Print Accuracy	± 250 Microns	Print Speed	25–120 mm/s Depending Upon Printing Material and Part Geometry	Print Head Travel Speed	25-150 mm/s	Build Plate	Glass Build Plate	Heating Bed	Silicon Heat Bed	Build Plate Temperature	Up to 100 °C	Build Plate Levelling	Auto Bed Levelling	Supported Materials	PLA, ABS, ASA, TPU, PETG, PC, PLA CF, PETG CF, ABS CF and many more (CF = Carbon Fibre)	Nozzle Temperature	Upto 285°C	Connectivity	SD Card, USB Port, Wi Fi, Bluetooth, LAN	Filament Sensor	Filament Runout Detection Filament Clogging Detection	Resume Print After Power Loss	Yes	Motion Mechanism	X on Belt Drive with Rail Guide Y on Belt Drive with Rail Guide Z on Ball Screw and Chromium Coated Steel Rods			Power Requirements		Input	100 -240V AC, 50-60Hz	Ambient conditions		Operating Ambient Temperature	15 -40° C, 10 -90% RH Non Condensing	Chamber	Fully Enclosed Chamber	Software		Supported OS	Mac OS, Windows and Linux	File types	STL, OBJ and 3MF	Machine Code	GCODE	1 Nos	
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9	<p>Video Recording (DSLR+V.C Room)</p> <ul style="list-style-type: none"> Body with Dual Lens: EF-S18-55 IS STM + EF-S 55-250 IS STM (16 GB SD Card + Camera Bag) Video Features 	1 Nos																																																															

	<p>Video Resolution 6000 x 4000 Video Quality 1080p at 60p + Time-Lapse Video Format MOV, MPEG-4 AVC / H.264 Other Video Features Recording Format: Design Rule for Camera File System (DCF) 2.0, Drive Modes: Single Shooting, Continuous Shooting, Silent Single Shooting, Silent Continuous Shooting, 10 sec Self-timer/Remote Control, 2 sec Delay, 10 sec Delay with Continuous Shooting, Maximum Burst - JPEG Large/Fine: Full, RAW: 6 Shots, RAW + JPEG Large / Fine: 6 Shots, Recorded Pixels: L (Large) - 24.0 MP (6000 x 4000), M (Medium) - 10.6 MP (3984 x 2656), S1 (Small 1) - 5.9 MP (2976 x 1984), S2 (Small 2) - 3.8 MP (2400 x 1600), RAW: 24.0 MP (6000 x 4000), Recording Size and Frame Rate: 1920 x 1080 (Full HD) - 59.94p / 50.00p / 29.97p / 25.00p / 23.98p, 1280 x 720 (HD) - 59.94p / 50.00p / 29.97p / 25.00p, 640 x 480 (VGA) - 29.97p / 25.00p</p> <ul style="list-style-type: none"> Audio Features Microphone Built-in Stereo Microphones Speaker Built-in Speaker Other Audio Features External Stereo Microphone Terminal Provided, Background Music, Audio Format: AAC, Sound-recording Level Adjustable, Wind Filter Provided, Attenuator Provided, Noise Reduction: Applicable to Long Exposures and High ISO Speed Shots Tripod Stand 		
10	<p>Projector</p> <p>Projection System 3,700 lumens 3LCD technology for equal white & colour light output resolution Long lamp life up to 12,000 hours*2 in ECO mode Easy setup and position HDMI connectivity RGB liquid crystal shutter projection system (3LCD) Connectivity: USB Interface :USB Type A: 1 (For Wireless LAN, Firmware Update For 20.28 mm Contrast Ratio:16,000:1,Wide: 33" to 320" [0.91 to 9.07 m,6,000 / 12,000] ±30° (Auto Vertical Keystone only),16:10 WXGA (1280 x 800) 2RCA (White & Red):</p> <p>White Motorized Projection Screen, Size:6*8 8*6 inch Motorized Projector Screen electric motor to raise</p> <p>2-4 Feet Black Ceiling/Wall Mount Projector Stand (Maximum Load Capacity 20 kg)</p> <p>15 Meter 4K HDMI Male to HDMI Male Cable TV Lead 1.4V High Speed Ethernet 3 HDMI Cable (Black for Computer, Laptop, Tablet)</p> <p>Electrical box, wire, clips, connector, modular box, lancable, and other required accessories</p> <p>Wireless Presenter Mini USB Receiver,AAA battery, Carry Pouch, Interface - USB Buttons - 6 ,Effective Range - Up to 30 m OS Supported - Windows® / Mac® / Linux® / Android® Dimensions - 2 cm (H) x 1.9 cm (W) x 13.9 cm (D),Weight - 20 g Power source - 1 x AAA Size Alkaline Battery, Laser Light range - Up to 100 m</p>	1 Nos	

Note: - 1. Presently the total number of computer systems& ICT items required in the centre with above said configurations is tentatively. However, the requirement may vary on monthly basis.

2. The Bidder may quote for higher specifications but the price competitiveness shall be given due consideration while analyzing the Financial bid.

Documents to be enclosed with the Technical bid are as under:

- a. Duly signed & stamped Tender documents as a mark of your acceptance should be duly filled wherever required.
- b. Copies of PAN,TIN/ Service Tax/VAT/GST registration duly Signed & Stamped.
- c. List of major clients to be annexed with complete contact details in the format below whom similar services have been provided during last one year

S.No.	Name of Client	Period of Services Provided	Contact Person	Contact Details
				Phone No.-Email ID - Address-

Signature of the Tenderer
With stamp

SANGAM RISE FOUNDATION

Sangam University, Panchayat Atun, Pur Road, Bhilwara- 311001, Rajasthan

E-mail: sangamrise@sangamuniversity.ac.in

(Section 8 Company registered under the Companies Act, 2013 (18 of 2013))

Annexure -II

FINANCIAL BID FORMAT **FORMAT & REQUIREMENTS FOR TENDER**

1. Tender Ref.No.:.....
2. Name of the Tenderer:.....
3. The offer with rates in rupees for the schedule of requirements of items, as elaborated under, to be submitted. Adhering to the format given below is a Pre-requisite for considering your quotations:

S. No.	Specification: Procurement of Computer Systems & ICT items.	Quantity	Unit Price Excluding all Taxes & Charges	Total in Rs. Including all Taxes & Charges
1	Desktop	2 Nos		
2	UPS Support – 1 nos for 20 Systems	1 Nos		
3	Multicolor Printer with Photocopying Facility	2 Nos		
4	Laptop	5 Nos		
5	Digital Podium-Metallic Integrated Podium	1 Nos		
6	Multi Touch Monitor	1 Nos		
7	Computer System-i7/13 th Gen/8 GB RAM/512 GB SSD Window 11 Audio System	1 Nos		
8	3 D Printer (RESIN) Printing Material: Resin Build Volume:5''x5''x5'' Supported file type: STL,OBJ Software: From Labs Perform	1 Nos		
9	Video Recording (DSLR+V.C Room)	1 Nos		
10	Projector	1 Nos		

Note : 1 The rate quoted shall be in accounting units(A/U) and should be including & all other costs (as applicable).

The Bidder may quote for higher specification but the price competitiveness shall be given due consideration while analyzing the Financial bid.

2 Successful bidder shall be selected on the basis of cost competitive offer in the lines of our requirements.

3 The validity of the tender is 3 Months from date of opening of bid.

4 The rate quoted here shall not be enhanced 3 Months, however the taxes shall be paid as

applicable at that time.

It is hereby confirmed that we shall abide by all the terms & conditions as specified in this tender.

**SignatureoftheTenderer
Withstamp**

MANDATE FORM FOR ELECTRONIC FUND TRANSFER/RTGS TRANSFER

Date: / /

To,

**Chairman Finance and Purchase Committee, Sangam Rise
Foundation, Sangam University, Panchayat Atun, Pur
Road, Bhilwara- 311001, Rajasthan
E-mail: sangamrise@sangamuniversity.ac.in**

Sub: Authorization for release of payment / dues from Sangam University, Bhilwara, Rajasthan through Electronic Fund Transfer/RTGS Transfer.

1. Name of the Party/Firm/Company/Institute:
2. Address of the Party:
3. Particulars of Bank;

Bank Name		Branch Name	
Branch Place		Branch City	
PIN Code		Branch Code	
MICR No			
(9 Digit number appearing on the MICR Bank of the Cheque supplied by the Bank, please attach a Xerox copy to a cheque of the bank for ensuring accuracy of the bank name, branch name and code number)			
IFS Code: (11 digit alphanumeric code)			
Account Type	Savings	Current	Cash Credit
Account Number:			

DECLARATION

I hereby declare that the particulars given above are correct and complete. If any transaction delayed and not effected for reasons of incomplete or incorrect information, I shall not hold Chairman Finance and Purchase Committee, Sangam University, Bhilwara responsible. I also undertake to advise any change in the particulars of my account to facilitate updating of records for purpose of credit of amount through NEFT/RTGS Transfer.

Place: _____

Date: _____

Signature & Seal of the Authorized Signatory of the Party

Certified that particulars furnished above are correct as per our records

Bankers Stamp:

Date: _____

Signature of the Authorized Official from the Bank

N.B.: Please fill all the information in CAPITAL LETTERS, computer typed; please TICK wherever it is applicable.

AGREEMENT

(To be executed on a non-judicial stamp of Rajasthan state @ Rs.1000)

An agreement made thisday ofbetween.....hereinafter called as „the Supplier“), which expression shall, where the context so admits, be deemed to include his heirs successors, executors and administrators of the one part and the Chairman Finance and Purchase Committee, Sangam Rise Foundation, Sangam University, Panchayat Atun, Pur Road, Bhilwara - 311001, Rajasthan herein after called „the Procuring Entity“ which expression shall, where the context so admits, be deemed to include his successors in office and assigns, of the other part.

WHEREAS the Procuring Entity invites Bids for certain Goods and Related Services ,viz.

.....
.....

and has accepted a Bid by the Supplier for the supply of those Goods and Related Services for the sum of.....(Amount in figures and words)
(Hereinafter „the Contract Price“).

NOW THIS AGREEMENT WITNESSTH ASFOLLOWS:

1. In this Agreement words and expressions shall have the same meanings as are respectively assigned to them in the Contract referred to.
2. The following documents shall be deemed to form and be read and construed as a part of this Agreement,viz.
 - (a) The Procuring Entity“s Notification to the Supplier of Award of Contract;
 - (b) The Bid Submission Sheet and the Price Schedule including negotiated price, if any, submitted by the Supplier;
 - (c) The Special Conditions of the Contract;
 - (d) The General Conditions of Contract;
 - (e) The SCHEDULE OF Supply;
 - (f) Instructions to Bidders;

(g) The Notice Inviting Bids

In the event of any discrepancy or inconsistency within the Contract, the documents shall prevail in the order listed above

3. In consideration to the payments to be made by the Procuring Entity to the Supplier as indicated in this Agreement, the Supplier hereby covenants with the Procuring Entity to provide the Goods and Related Services and to remedy defects therein in conformity in all respects with the provisions of the Contract.
4. The Procuring Entity hereby covenants to pay the Supplier in consideration of the provision of the Goods and Related Services and the remedying of the defects therein, the Contract Price or such other sum as may become payable under the Provisions of the contract at the times and in the manner prescribed by the Contract.

IN WITNESS whereof the parties hereto have caused this Agreement to be executed in accordance with the laws of the Central and the State Government on the day, month and year first mentioned herein before.

Witness 1

Signed by:

(for the Supplier)

Name

Designation.....

Address

.....

Witness 2

Signed by:

(for the Procuring Entity)

Name

Designation.....

Address

.....